# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



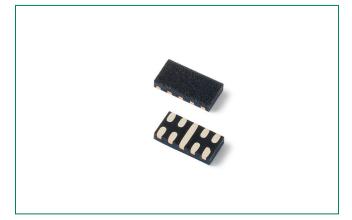
# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

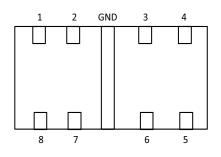




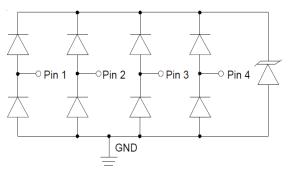
## SP0544T Series 0.5pF 12KV Diode Array



#### Pinout



#### **Functional Block Diagram**



Note: Pins 5-8 not internally connected

#### Description

The SP0544T integrates 4 channels of ultra low capacitance rail-to-rail diodes and an additional zener diode to provide protection for electronic equipment that may experience destructive electrostatic discharges (ESD). This robust device can safely absorb repetitive ESD strikes above the maximum level specified in the IEC61000-4-2 international standard (±8kV contact discharge) without performance degradation. The extremely low loading capacitance also makes it ideal for protecting high speed signal pins such as V-By-One, HDMI, USB3.0, USB2.0, and IEEE 1394.

#### Features

- ESD, IEC61000-4-2, ±12kV contact, ±25kV air
- EFT, IEC61000-4-4, 40A (tP=5/50ns)
- Lightning, IEC61000-4-5 2<sup>nd</sup> edition, 4A (tP=8/20µs)
- Low capacitance of 0.5pF (TYP) per I/O
- Low leakage current of 1.5µA (MAX) at 5V

RoHS

(P6) GREEN

Halogen free, Lead free
and RoHS compliant

#### Applications

- V-By-One
- Embedded DisplayPort
- USB 2.0/3.0 Ports
- HDMI

- Flat Panel Displays
- LCD/LED TVs
- Smartphones
- Mobile Computing

Life Support Note: Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

#### **Absolute Maximum Ratings**

Symbol	Parameter	Value	Units	
I <sub>PP</sub>	Peak Current (t <sub>p</sub> =8/20µs)	4.0	А	
T <sub>op</sub>	Operating Temperature	-40 to 150	°C	
T <sub>stor</sub>	Storage Temperature	-55 to 150	°C	

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

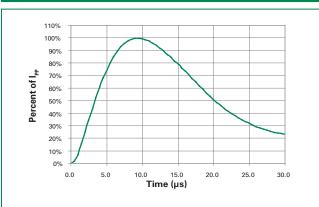
#### Electrical Characteristics (T<sub>OP</sub>=25°C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	V <sub>RWM</sub>	I <sub>R</sub> ≤ 1µA			5.0	V
Reverse Leakage Current	LEAK	V <sub>R</sub> =5V, Any I/O to GND			1.5	μA
Clamp Voltage <sup>1</sup>	V <sub>c</sub>	I <sub>PP</sub> =1A, t <sub>p</sub> =8/20μs, Fwd		6.6		V
		I <sub>PP</sub> =2A, t <sub>p</sub> =8/20μs, Fwd		7.0		V
Dynamic Resistance <sup>2</sup>	R <sub>DYN</sub>	TLP, t <sub>p</sub> =100ns, I/O to GND		0.3		Ω
ESD Withstand Voltage <sup>1</sup>	V	IEC61000-4-2 (Contact)	±12			kV
	V <sub>ESD</sub>	IEC61000-4-2 (Air)	±25			kV
Diode Capacitance <sup>1</sup>	C <sub>I/O-GND</sub>	Reverse Bias=0V, f=1 MHz		0.5		pF
Diode Capacitance <sup>1</sup>	C <sub>I/O-/O</sub>	Reverse Bias=0V, f=1 MHz		0.3		pF

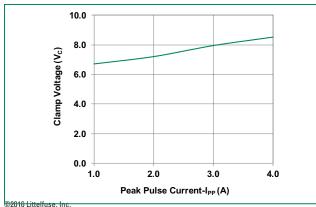
Note: <sup>1</sup> Parameter is guaranteed by design and/or device characterization.

<sup>2</sup> Transmission Line Pulse (TLP) with 100ns width and 2ns rise time.

#### 8/20µS Pulse Waveform

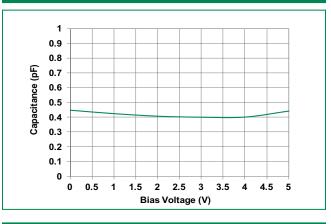


#### Clamping Voltage vs I

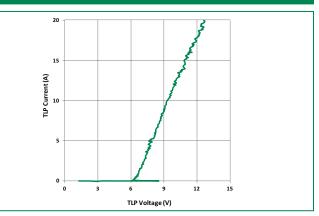


Specifications are subject to change without notice. Revision: 03/17/16

#### Capacitance vs. Reverse Bias



#### Transmission Line Pulsing(TLP) Plot

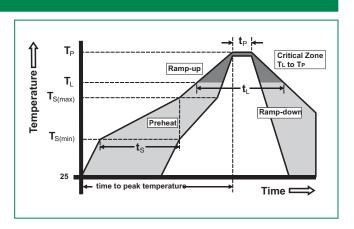




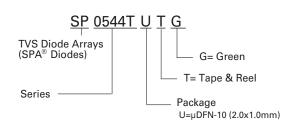
**TVS Diode Arrays** (SPA®Diodes) Low Capacitance ESD Protection - SP0544T Series

#### **Soldering Parameters**

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ra to peak	mp up rate (Liquidus) Temp ( $T_L$ )	3°C/second max	
$T_{S(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
- Temperature (t <sub>L</sub> )		60 – 150 seconds	
Peak Temp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		20 – 40 seconds	
Ramp-dow	n Rate	6°C/second max	
Time 25°C	to peak Temperature (T <sub>P</sub> )	8 minutes Max.	
Do not exceed		260°C	



#### Part Numbering System



#### **Product Characteristics**

Lead Plating	Pre-Plated Frame
Lead Material	Copper Alloy
Lead Coplanarity	0.004 inches(0.102mm)
Substrate material	Silicon
Body Material	Molded Epoxy
Flammability	UL 94 V-0

Notes :

1. All dimensions are in millimeters

2. Dimensions include solder plating.

3. Dimensions are exclusive of mold flash & metal burr.

4. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.

5. Package surface matte finish VDI 11-13.

#### Part Marking System

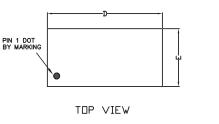


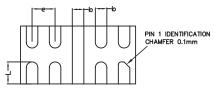
Ordering Information				
Part Number	Package	Marking	Min. Order Qty.	
SP0544TUTG	µDFN-10	⊕G4	3000	



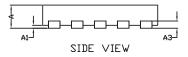
### **TVS Diode Arrays** (SPA®Diodes) Low Capacitance ESD Protection - SP0544T Series

#### Package Dimensions



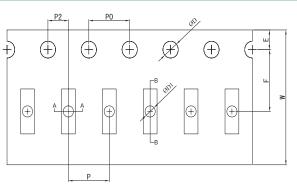


BOTTOM VIEW



<b>µ</b> DFN10 (2.0x1.0mm)						
	JEDEC MO-229					
Cumphiel	Millimeters			Inches		
Symbol	Min	Nom	Max	Min	Nom	Max
А	0.3	-	0.4	0.012	-	0.016
A1	0	-	0.05	0	-	0.002
A3	0.125 REF			0.049 REF		
D	1.95	2.00	2.05	0.077	0.079	0.081
E	0.95	1.00	1.05	0.037	0.039	0.041
b	0.15	0.20	0.25	0.006	0.008	0.010
L	0.28	0.38	0.48	0.011	0.015	0.019
е	0.40 BSC			0	.016 BSC	

#### **Embossed Carrier Tape & Reel Specification**





8
ко

B-B

Symbol	Millimeters		
A0	1.15 +/- 0.05		
B0	2.15 +/- 0.05		
D	Ø 1.55 + 0.1/- 0		
D1	Ø 0.80 + 0.25/- 0		
E	1.75 +/- 0.10		
F	3.50 +/- 0.05		
К0	0.48 +/- 0.05		
P 4.00 +/- 0.10			
P0	4.00 +/- 0.10		
P2 2.00 +/- 0.05			
Т	0.20 +/- 0.03		
W	8.00 + 0.30 /- 0.10		